Form PTO-1595



U.S. Department of Comme Patent and Trademark Office

**HEET** 101463752 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

			, T	
Name of conveying party(ies):			Name and address of receiving party(ies):	
Larry Hillyer, Steve Byrne, Kelly Williamson and Doug Hahn			Name: Micron Technology, Inc.	
		□ v <sub>22</sub>	Internal Address:	
Additional name(s		Yes		
party(ies) attache	a'?	x No	Street Address: 8000.S. Federal Way	
3. Nature of Conv				
x Assignment Merger			City: Boise	
Security Agreement Change of Name			State: <u>Idaho</u> Zip: <u>83707-0006</u>	
Other			Country:	
Execution Date(s): 8/31/00			Additional name(s) & Yes address(es) attached? x No	
4. Application nur	nber(s) or patent nu	mber(s):	7/ (053561	
	is being filed together		eation,	
	ate(s) of the new applic	cation is (are):	8/31/00 D. D. Hart No. (a):	
A. Patent Applica	ation No.(s):		B. Patent No.(s):	
			Additional numbers attached? Yes X No	
5. Name and address of party to whom correspondence concerning document should be mailed:			6. Total number of applications and patents involved:	
Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP			7. Total fee (37 C.F.R 3.41) \$\$40.00	
Internal Address:	Atty. Dkt.: M4065.02	39/P239	Enclosed	
Attn: Thomas J. D'Amico			X Authorized to be charged to deposit account	
Street Address:	2101 L Street NW		Credit any overpayment or debit any underpayment	
City: Washington	State: Zip: DC 200	37 - 1526	8. Deposit account number: 4 - 1073	
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9. Statement an	d signature		130	
To the heet of	f mv knowledge and	belief, the fored	going information is true and correct and any attached	
copy is a true	copy of the original	document.		
Thomas J. D'Amico			August 31, 2000	
		Signature	Date 기계	
Reg. No. 28,	371			
Total number of pages including cover sheet, attachments, and document: 6				

**PATENT REEL: 011073 FRAME: 0621** 

### ASSIGNMENT AND AGREEMENT

For value received, we, Larry Hillyer, Steve Byrne, Kelly Williamson and Doug Hahn, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD AND MATERIAL FOR REMOVING ETCH RESIDUE FROM HIGH ASPECT RATIO CONTACT SURFACES, described in an application for Letters Patent of the United States, executed by us of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

1118133 v1; NYR901!.DOC

PATENT REEL: 011073 FRAME: 0622

We agree that, when requested, we shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Date: \( \langle \( \langle \)	<i>0</i> 0	Larry Hillyer	lillege	
United States of America State County	) )ss.: ) )ss.:			
On this Personally came Larre individual described in a	day ofy Hillyer and who executed the		to me known ent, and acknow	
executivity who same.		Notary I	melled	1
ST. PUBLIC ST.				

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

### ASSIGNMENT AND AGREEMENT

Signature Page for Second Inventor

. 0 21	Steve Byrne
Date: 8-31-00	
United States of America	
State )ss.:	
County (1)	
On this 31 day of	1000 , before me
personally came Steve Byrne	, to me known to be the
individual described in and who executed the f	oregoing instrument, and acknowledged
execution of the same.	Seel . Azzland
Junior CA KECITE	Notary Public
ON TANK	rvotary r tronc
1. 50 X	
Si VBL VIII	

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## ASSIGNMENT AND AGREEMENT

Signature Page for Third Inventor

Date: 8/31/	co Kelly Will	William Son
United States of America State County	) )ss.: )	
	day of	, to me known to be the strument, and acknowledged
execution of the same.	News	otary Public

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#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

### ASSIGNMENT AND AGREEMENT

Signature Page for Fourth Inventor

Date: 8/31/60	Doug Hann
United States of America State County	) _ )ss.: _ )
	, to me known to be the ated the foregoing instrument, and acknowledged
execution of the same.	Notary Public

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**RECORDED: 08/31/2000** 

PATENT REEL: 011073 FRAME: 0626